# BLF7G22L-130; BLF7G22LS-130 Power LDMOS transistor Rev. 5 – 1 September 2015

AMPLEON Product data sheet

#### **Product profile** 1.

# 1.1 General description

130 W LDMOS power transistor for base station applications at frequencies from 2000 MHz to 2200 MHz.

#### **Typical performance** Table 1.

Typical RF performance at  $T_{case} = 25 \ ^{\circ}C$  in a common source class-AB production test circuit.

Mode of operation	f	I <sub>Dq</sub>	$V_{\text{DS}}$	P <sub>L(AV)</sub>	Gp	$\eta_D$	ACPR
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
2-carrier W-CDMA	2110 to 2170	950	28	30	18.5	32	-32 <mark>[1]</mark>
1-carrier W-CDMA	2110 to 2170	950	28	33	18.5	33	-39 <mark>[2]</mark>

[1] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF; carrier spacing 5 MHz.

[2] Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

### 1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low R<sub>th</sub> providing excellent thermal stability
- Designed for broadband operation (2000 MHz to 2200 MHz)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent digital pre-distortion capability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

RF power amplifiers for W-CDMA base stations and multi carrier applications in the 2000 MHz to 2200 MHz frequency range

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**Power LDMOS transistor** 

# 2. Pinning information

Pin	Description		Simplified outline	Graphic symbol
BLF7G22	2L-130 (SOT502A)			
1	drain			
2	gate			1 لــــا
3	source	<u>[1]</u>		
				3 sym112
BLF7G22	2LS-130 (SOT502B)			·
1	drain			
2	gate			1 لــــا
3	source	<u>[1]</u>		
				sym112

# 3. Ordering information

Table 3. Ordering information				
Type number Package				
	Name	Description	Version	
BLF7G22L-130	-	flanged LDMOST ceramic package; 2 mounting holes; 2 leads	SOT502A	
BLF7G22LS-130	-	earless flanged LDMOST ceramic package; 2 leads	SOT502B	

# 4. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage		-	65	V
V <sub>GS</sub>	gate-source voltage		-0.5	+13	V
I <sub>D</sub>	drain current		-	28	А
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	225	°C

# 5. Thermal characteristics

Table 5.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-c)</sub>	thermal resistance from junction to case	$T_{case}$ = 80 °C; $P_L$ = 30 W	0.35	K/W

# 6. Characteristics

### Table 6. Characteristics

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

•					
Parameter	Conditions	Min	Тур	Мах	Unit
drain-source breakdown voltage	$V_{GS}$ = 0 V; I <sub>D</sub> = 1.5 mA	65	-	-	V
gate-source threshold voltage	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 150 mA	1.3	1.8	2.3	V
drain leakage current	$V_{GS}$ = 0 V; $V_{DS}$ = 28 V	-	-	5	μA
drain cut-off current	$\label{eq:VGS} \begin{array}{l} V_{\mathrm{GS}} = V_{\mathrm{GS}(\mathrm{th})} + 3.75 \; V; \\ V_{\mathrm{DS}} = 10 \; V \end{array}$	25	29.5	-	A
gate leakage current	$V_{GS}$ = 11 V; $V_{DS}$ = 0 V	-	-	450	nA
forward transconductance	V <sub>DS</sub> = 10 V; I <sub>D</sub> = 7.5 A	-	10	11	S
drain-source on-state resistance	V <sub>GS</sub> = V <sub>GS(th)</sub> + 3.75 V; I <sub>D</sub> = 5.25 A	-	0.1	0.16	Ω
	drain-source breakdown voltage gate-source threshold voltage drain leakage current drain cut-off current gate leakage current forward transconductance	drain-source breakdown voltage $V_{GS} = 0 \text{ V}; \text{ I}_D = 1.5 \text{ mA}$ gate-source threshold voltage $V_{DS} = 10 \text{ V}; \text{ I}_D = 150 \text{ mA}$ drain leakage current $V_{GS} = 0 \text{ V}; \text{ V}_{DS} = 28 \text{ V}$ drain cut-off current $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ gate leakage current $V_{GS} = 11 \text{ V}; \text{ V}_{DS} = 0 \text{ V}$ gate leakage current $V_{DS} = 10 \text{ V}; \text{ I}_D = 7.5 \text{ A}$ drain-source on-state resistance $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$	$ \begin{array}{ll} \mbox{drain-source breakdown voltage} & V_{GS} = 0 \ V; \ I_D = 1.5 \ mA & 65 \\ \mbox{gate-source threshold voltage} & V_{DS} = 10 \ V; \ I_D = 150 \ mA & 1.3 \\ \mbox{drain leakage current} & V_{GS} = 0 \ V; \ V_{DS} = 28 \ V & - \\ \mbox{drain cut-off current} & V_{GS} = V_{GS(th)} + 3.75 \ V; \\ \mbox{ds} = 10 \ V \\ \mbox{gate leakage current} & V_{GS} = 11 \ V; \ V_{DS} = 0 \ V & - \\ \mbox{forward transconductance} & V_{DS} = 10 \ V; \ I_D = 7.5 \ A & - \\ \mbox{drain-source on-state resistance} & V_{GS} = V_{GS(th)} + 3.75 \ V; & - \\ \end{array} $	$ \begin{array}{llllllllllllllllllllllllllllllllllll$	drain-source breakdown voltage $V_{GS} = 0 \text{ V}; \text{ I}_D = 1.5 \text{ mA}$ 65gate-source threshold voltage $V_{DS} = 10 \text{ V}; \text{ I}_D = 150 \text{ mA}$ 1.31.82.3drain leakage current $V_{GS} = 0 \text{ V}; \text{ V}_{DS} = 28 \text{ V}$ 5drain cut-off current $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$ 2529.5-gate leakage current $V_{GS} = 11 \text{ V}; \text{ V}_{DS} = 0 \text{ V}$ 450forward transconductance $V_{DS} = 10 \text{ V}; \text{ I}_D = 7.5 \text{ A}$ -1011drain-source on-state resistance $V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ -0.10.16

# 7. Test information

#### Table 7. Functional test information

Mode of operation: 2-carrier W-CDMA; PAR = 8.4 dB at 0.01 % probability on the CCDF; 3GPP test model 1; 64 DPCH;  $f_1$  = 2112.5 MHz;  $f_2$  = 2117.5 MHz;  $f_3$  = 2162.5 MHz;  $f_4$  = 2167.5 MHz; RF performance at  $V_{DS}$  = 28 V;  $I_{Dq}$  = 950 mA;  $T_{case}$  = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$P_{L(AV)}$	average output power		-	30	-	W
G <sub>p</sub>	power gain	P <sub>L(AV)</sub> = 30 W	17	18.5	-	dB
RL <sub>in</sub>	input return loss	P <sub>L(AV)</sub> = 30 W	-	-15	-9	dB
$\eta_D$	drain efficiency	P <sub>L(AV)</sub> = 30 W	29	32	-	%
ACPR	adjacent channel power ratio	P <sub>L(AV)</sub> = 30 W	-	-31	-28	dBc

### 7.1 Ruggedness in class-AB operation

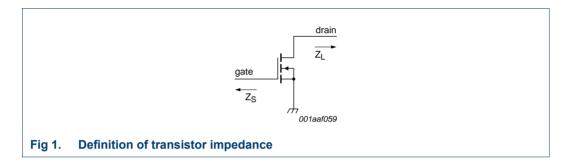
The BLF7G22L-130 and BLF7G22LS-130 are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS}$  = 28 V;  $I_{Dq}$  = 950 mA;  $P_L$  = 130 W (CW); f = 2110 MHz.

# 7.2 Impedance information

### Table 8. Typical impedance information

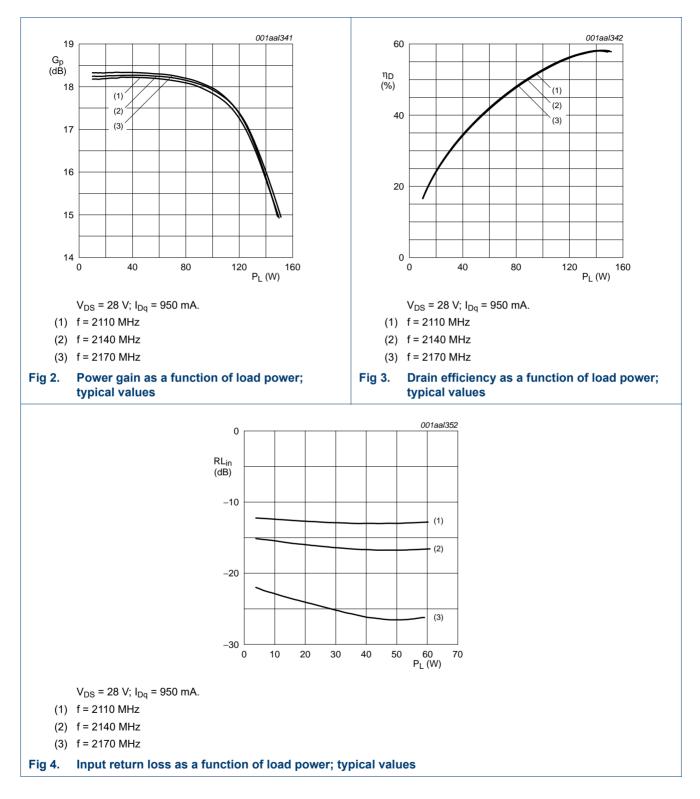
 $I_{Dq} = 950 \text{ mA}$ ; main transistor  $V_{DS} = 28 \text{ V}$ .  $Z_S$  and  $Z_L$  defined in Figure 1.

f (MHz)	Z <sub>S</sub> (Ω)	Z <sub>L</sub> (Ω)
2050	1.3 – j3.6	2.2 – j2.6
2140	1.9 – j4.2	2.0 – j2.6
2230	3.1 – j4.7	1.9 – j2.8



# BLF7G22L-130; BLF7G22LS-130

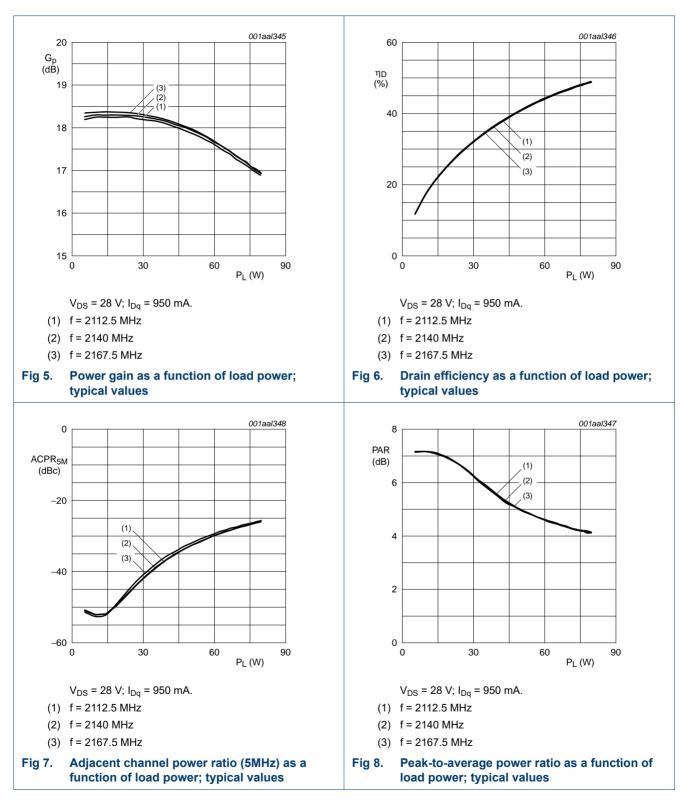
**Power LDMOS transistor** 



7.3 1 Tone CW

## 7.4 1-carrier W-CDMA

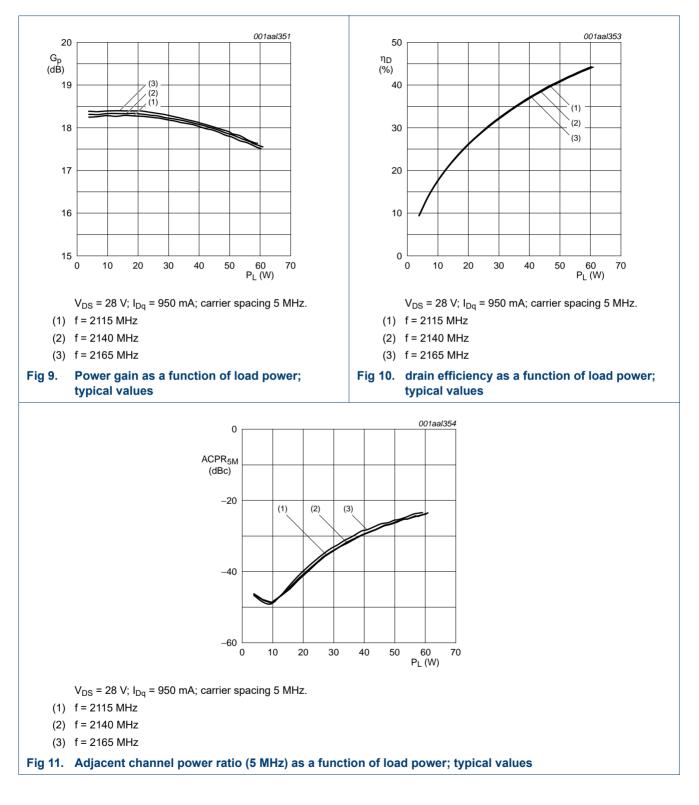
Test signal: 3GPP; test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.



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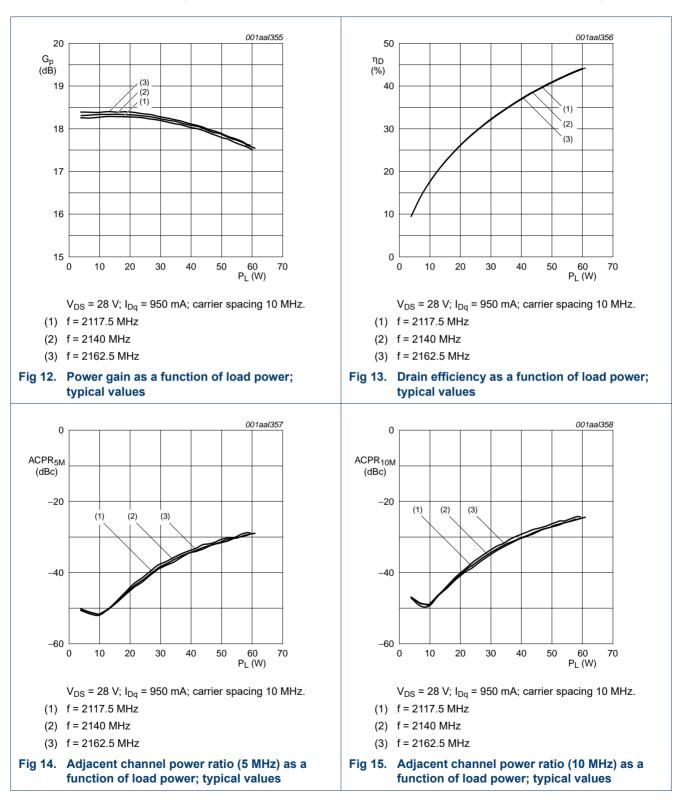
# 7.5 2-carrier W-CDMA (5 MHz carrier spacing)

Test signal: 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF.



# 7.6 2-carrier W-CDMA (10 MHz carrier spacing)

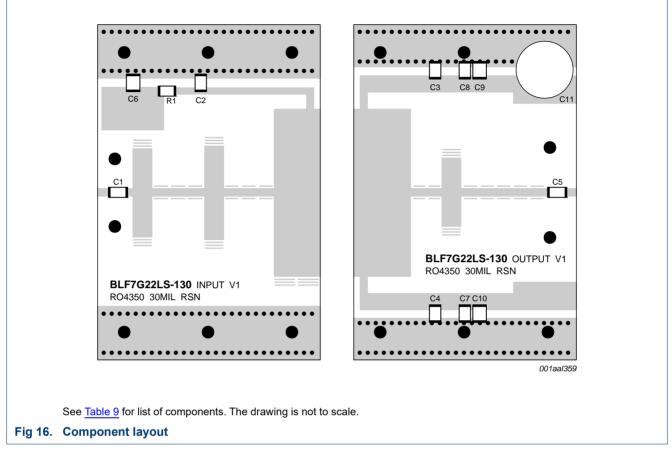
Test signal: 3GPP; test model 1; 64 DPCH; PAR = 8.4 dB at 0.01 % probability on CCDF.



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**Power LDMOS transistor** 

### 7.7 Test circuit



# Table 9.List of componentsSee Figure 16 for component layout.

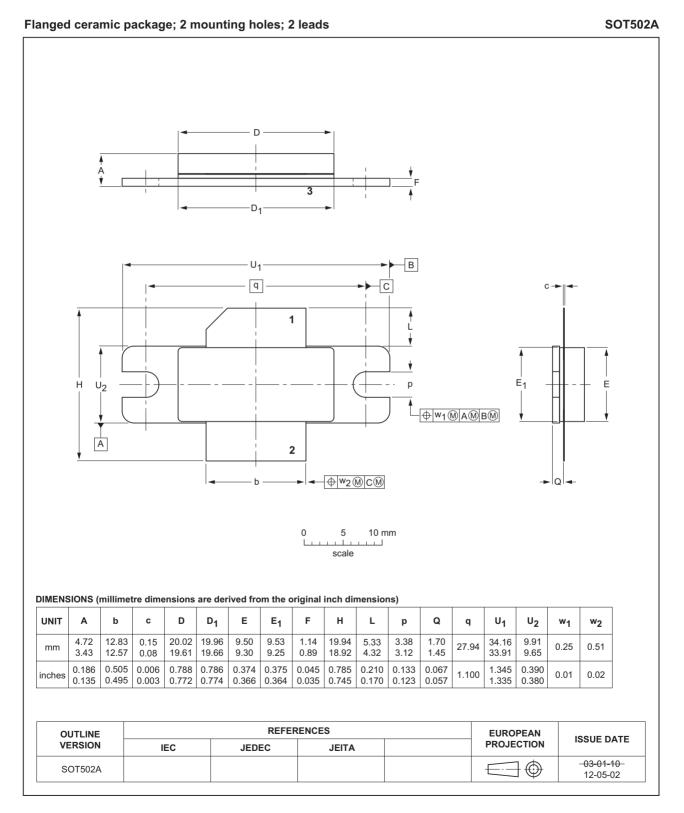
Component	Description	Value	Remarks
C1, C2, C3, C4, C5	multilayer ceramic chip capacitor	9.1 pF	ATC100B
C6, C7	multilayer ceramic chip capacitor	220 nF	AVX1206
C8, C9, C10	multilayer ceramic chip capacitor	4.7 μF; 50 V	Kemet
C11	electrolytic capacitor	220 μF; 63 V	BC
R1	SMD resistor	6.2 Ω	Philips 1206

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**Power LDMOS transistor** 

# 8. Package outline



### Fig 17. Package outline SOT502A

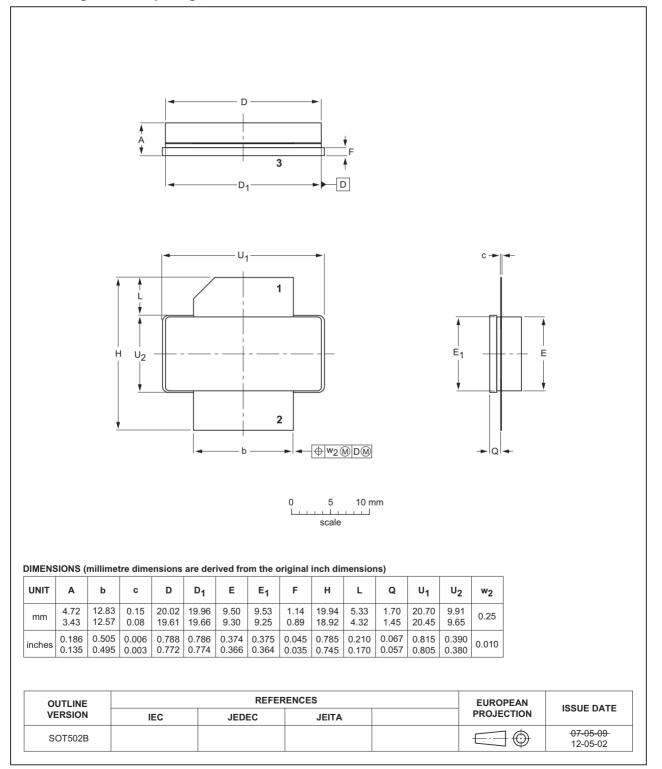
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### **Power LDMOS transistor**

SOT502B

Earless flanged ceramic package; 2 leads



### Fig 18. Package outline SOT502B

# 9. Abbreviations

Table 10. Al	bbreviations
Acronym	Description
3GPP	Third Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
ESD	ElectroStatic Discharge
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LDMOST	Laterally Diffused Metal Oxide Semiconductor Transistor
PAR	Peak-to-Average power Ratio
RF	Radio Frequency
SMD	Surface Mounted Device
VSWR	Voltage Standing Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

# **10. Revision history**

### Table 11.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF7G22L-130_7G22LS-130#5	20150901	Product data sheet	-	BLF7G22L-130_7G22 LS-130 v.4
Modifications:		of this document has beer lelines of Ampleon.	n redesigned to con	nply with the new
	<ul> <li>Legal texts</li> </ul>	have been adapted to the	new company nam	e where appropriate.
BLF7G22L-130_7G22LS-130 v.4	20110120	Product data sheet	-	BLF7G22LS-130 v.3
BLF7G22L-130_7G22LS-130 v.3	20101118	Product data sheet	-	BLF7G22LS-130 v.2
BLF7G22L-130_7G22LS-130 v.2	20101004	Product data sheet	-	BLF7G22LS-130 v.1
BLF7G22LS-130 v.1	20100202	Product data sheet	-	-

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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